

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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Name	Execution Date
SEONG OOK JEONG	04/28/2016
JONG KUN LEE	04/28/2016
SEUNG WOK HAN	04/28/2016
KYUNG SUB MIN	04/28/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15159948
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Total Attachments: 2	
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Assignment of Invention and Patent Application

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration,

- 1) Seong Ook JEONG of 901-1703, Byeokjeokgol 9 Danji Apt., 27, Bongyeong-ro 1517beon-gil, Yeongtong-gu, Suwon-si, Gyeonggi-do 16700, Republic of Korea
- 2) Jong Kun LEE of 602, Dream Villa, 41-3, Deogyong-daero 1471beon-gil, Yeongtong-gu, Suwon-si, Gyeonggi-do 16681, Republic of Korea
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- 4) Kyung Sub MIN of 709-301, BotdulMaeul 7 Danji Apt., 155, Dongpangyo-ro, Bundang-gu, Seongnam-si, Gyeonggi-do 13525, Republic of Korea

(hereinafter **Assignor**) hereby sells, assigns, transfers, and sets over unto:

SAMSUNG ELECTRONICS CO., LTD. of
129 SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO, 16677
REPUBLIC OF KOREA

(hereinafter **Assignee**) the entire right, title and interest for the United States Of America as defined in 35 U.S.C. Section 261, in and to the invention entitled as:

SENSOR INFORMATION USING METHOD AND ELECTRONIC DEVICE USING THE SAME

invented by **Assignor**; the application for United States patent therefor, invented by **Assignor**; any patent or reissues of any patent that may be granted thereon; and any applications which are continuations, continuation-in-part, substitutes, or divisions of said application. **Assignor** authorizes **Assignee** to enter the date of signature and/or Serial Number and Filing Date in the above. **Assignor** also authorizes and requests the Commissioner of Patents and Trademarks to

issue any resulting patent(s) to the said **Assignee**, for its interests as **Assignee**, its successors, assigns and legal representatives. The undersigned agrees that the attorney of record in said application shall hereafter act on behalf of said **Assignee**; and **Assignor** further conveys to **Assignee** all priority rights resulting from the above-identified application for United States Patent. **Assignor** agrees to execute all papers, give any required testimony and perform other lawful acts, as deemed essential by **Assignee** to perfect **Assignee's** interest in any resulting patent of the United States, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and **Assignee's** interest therein.

SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):

Name of First Inventor: Seong Ook JEONG

Seong Ook Jeong

Signature of inventor

Dated: 28 April 2016

WITNESSED: _____

Name of Second Inventor: Jong Kun LEE

Jong Kun Lee

Signature of inventor

Dated: 28 April 2016

WITNESSED: _____

Name of Third Inventor: Seung Wok HAN

Seung Wok Han

Signature of inventor

Dated: 28 April 2016

WITNESSED: _____

Name of Fourth Inventor: Kyung Sub MIN

Kyung Sub MIN

Signature of inventor

Dated: 28 April 2016

WITNESSED: _____